





#### **DUAL SURFACE MOUNT SWITCHING DIODE**

### **Features**

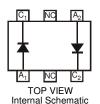
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SOT-563
- Case Material: Molded Plastic.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.003 grams (Approximate)







Note 5

**Ordering Information** (Note 4)

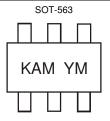
Part Number	Case	Packaging		
BAS16V-7	SOT-563	3,000/Tape & Reel		

SOT-563

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- 5. Package is non-polarized. Parts may be on reel in orientation illustrated, 180° rotated, or mixed (both ways).

## **Marking Information**



KAM = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: T = 2006)

M = Month (ex: 9 = September)

### Date Code Key

Year	2004	2005	2006	2007	2008	2009	2010	2011	201	2 20	13 201	4 2015	2016	2017
Code	R	S	Т	U	V	W	Χ	Υ	Z	Α	В	С	D	Е
Monti	h	Jan	Feb	Mar	Apr	May	/ Ju	n ,	Jul	Aug	Sep	Oct	Nov	Dec
Code		1	2	Q	1	5	6		7	Ω	Q	0	N	D



## **Maximum Ratings** (@T<sub>A</sub> = +25 ℃, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	٧
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current	(Note 6)	I <sub>FM</sub>	300	mA
Average Rectified Output Current	(Note 6)	Io	200	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	A

# Thermal Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 6)	$P_d$	150	mW	
Thermal Resistance Junction to Ambient Air	(Note 6)	$R_{ hetaJA}$	833	°C/W	
Operating and Storage Temperature Range		T <sub>j</sub> , T <sub>STG</sub>	-65 to +150	∞	

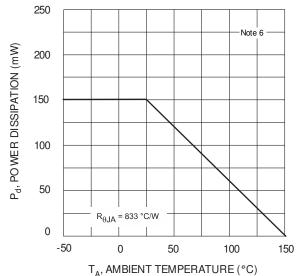
# **Electrical Characteristics** (@ $T_A = +25$ °C, unless otherwise specified.)

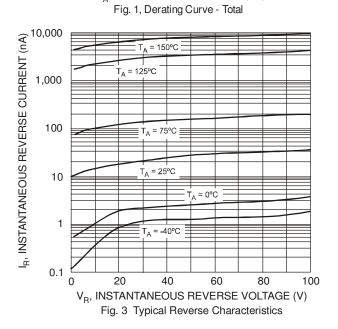
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	75	_	V	$I_R = 100 \mu A$
Forward Voltage	V <sub>F</sub>	l	0.715 0.855 1.0 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 7)	I <sub>R</sub>		1.0 50 30 25	μΑ μΑ Α nA	$V_R = 75V$ $V_R = 75V$ , $T_i = +150$ °C $V_R = 25V$ , $T_j = +150$ °C $V_R = 20V$
Total Capacitance	C <sub>T</sub>	_	2.0	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$\begin{split} I_F &= I_R = 10 mA, \\ I_{rr} &= 0.1 \times I_R, \ R_L = 100 \Omega \end{split}$

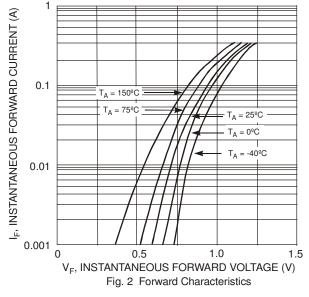
<sup>Notes:
6. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
7. Short duration pulse test used to minimize self-heating effect.</sup> 











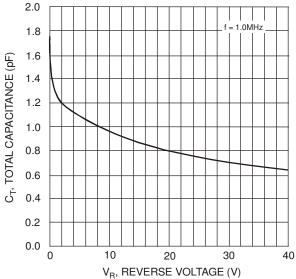
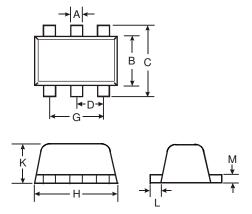


Fig. 4 Typical Capacitance vs. Reverse Voltage



## **Package Outline Dimensions**

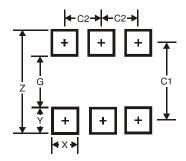
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	-	0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
K	0.55	0.60	0.60				
L	0.10	0.30	0.20				
M	0.10	0.18	0.11				
All	All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5

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